



DYNAMIC GLASS TRANSITION OF CHLOROPRENE RUBBER UNDER STRESS BY TEMPERATURE- MODULATED DSC

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Introduction

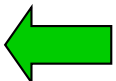
Recently **dynamic heat capacity** of various polymers has been measured by using **TMDSC** (temperature-modulated DSC).

One of main aims of such measurements

In the glass transition region

- **vitrification**
- **relaxation process**

Experimental

The **dynamic heat capacity** in the glass transition region for various frequencies  TMDSC

relaxed and stressed rubbers

- Sample : **Chloroprene rubber** (+ 35per Carbon black)
(Engineer use typical synthetic rubber)
- DSC : DSC822e/400 (METTLER TOLEDO)
- Experimental condition :

Amplitude = 0.5 K

Heating rate = 1 K/min

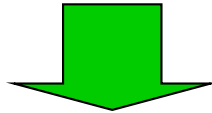
Period = 60,75,90,105,120,135,150,165,180,210,240,300s

(But stressed rubber are 60, 90, 120, 150,180,210,240s)

relaxed and stressed rubbers

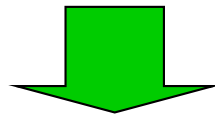
The **heat capacity spectroscopy** in the glass transition region

{ the real part : c'
the imaginary part : c''



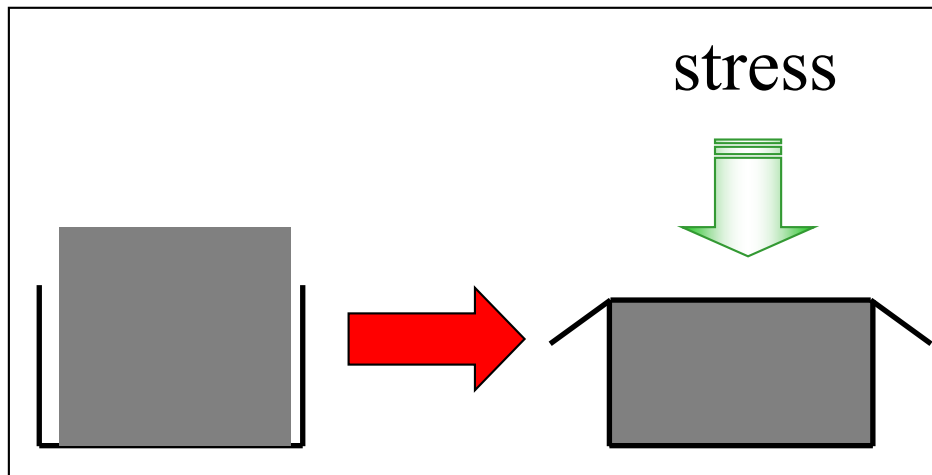
The frequencies dependence of the dynamic glass transition temperature T_g

We understand by well known non-Arrhenius type **VFTH (Vogel-Fulcher-Tamman-Hesse) equation**



The temperature dependent on the glass transition **cooperativity** N_α from the **fluctuation approach**

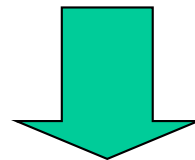
Sample preparation for the stressed rubber



The stressed rubber is compressed by the lid with screw.

About **5MPa** pressure is given for the sample around T_g temperature.

When the rubber is compressed by the stress, the free volume is reduced due to the compression of the phase space.



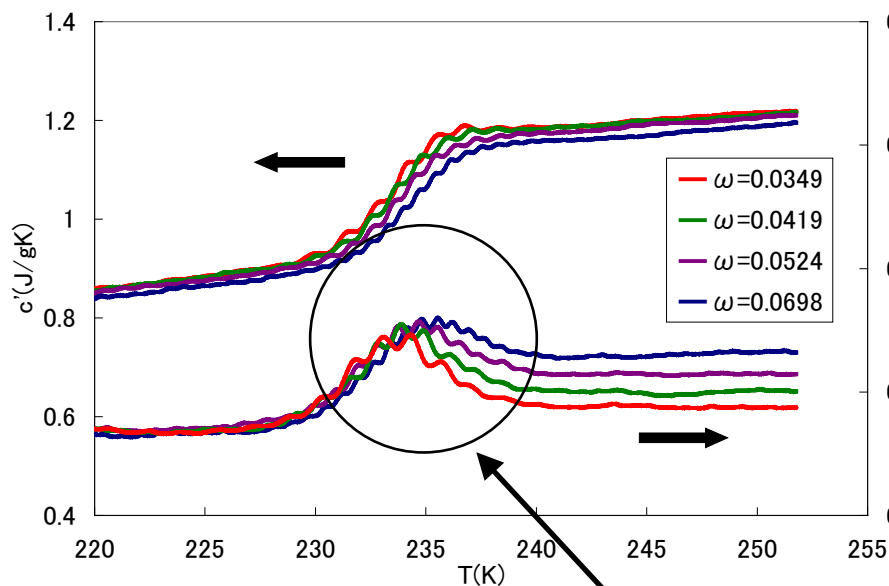
How **VFTH parameters** and **cooperativity** for stressed rubber change.

Results

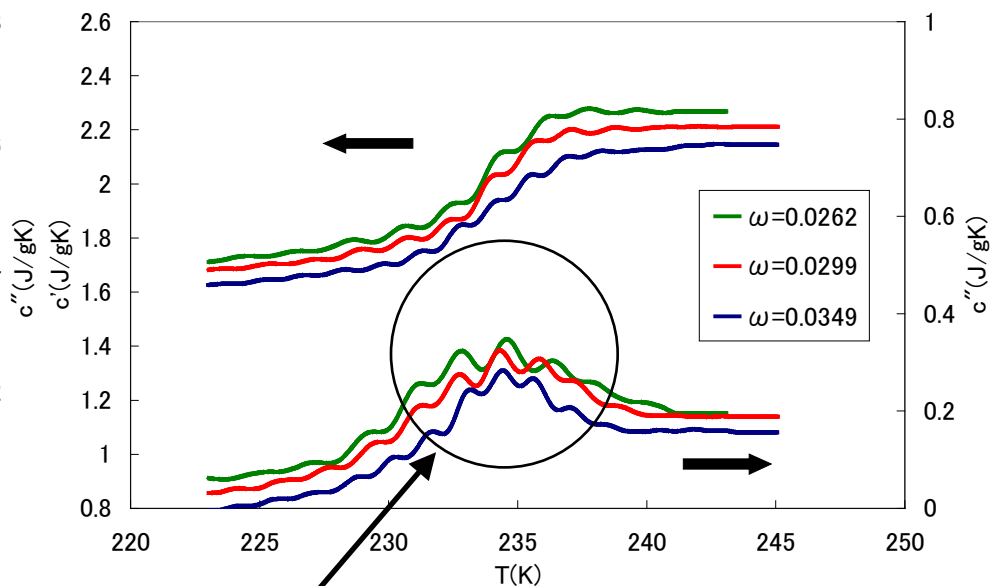
The **heat capacity spectroscopy** in the glass transition region

{ the real part : c'
the imaginary part : c''

Relaxed rubber



Stressed rubber



The dynamic glass transition temperature T_g

The Politecnico di Torino
Thermal Analysis and Calorimetry,

Italy, 2004

Analysis

We used well known non-Arrhenius type

Vogel-Fulcher-Tamman-Hesse (VFTH) equation.

VFTH equation

$$\log \omega = A + \frac{B}{T - T_{\infty}}$$

VFTH parameter :

Relaxed rubber

$$A = 12.03$$

$$B = -688.88 \text{ K}$$

$$T_{\infty} = 181.88 \text{ K}$$

Stressed rubber

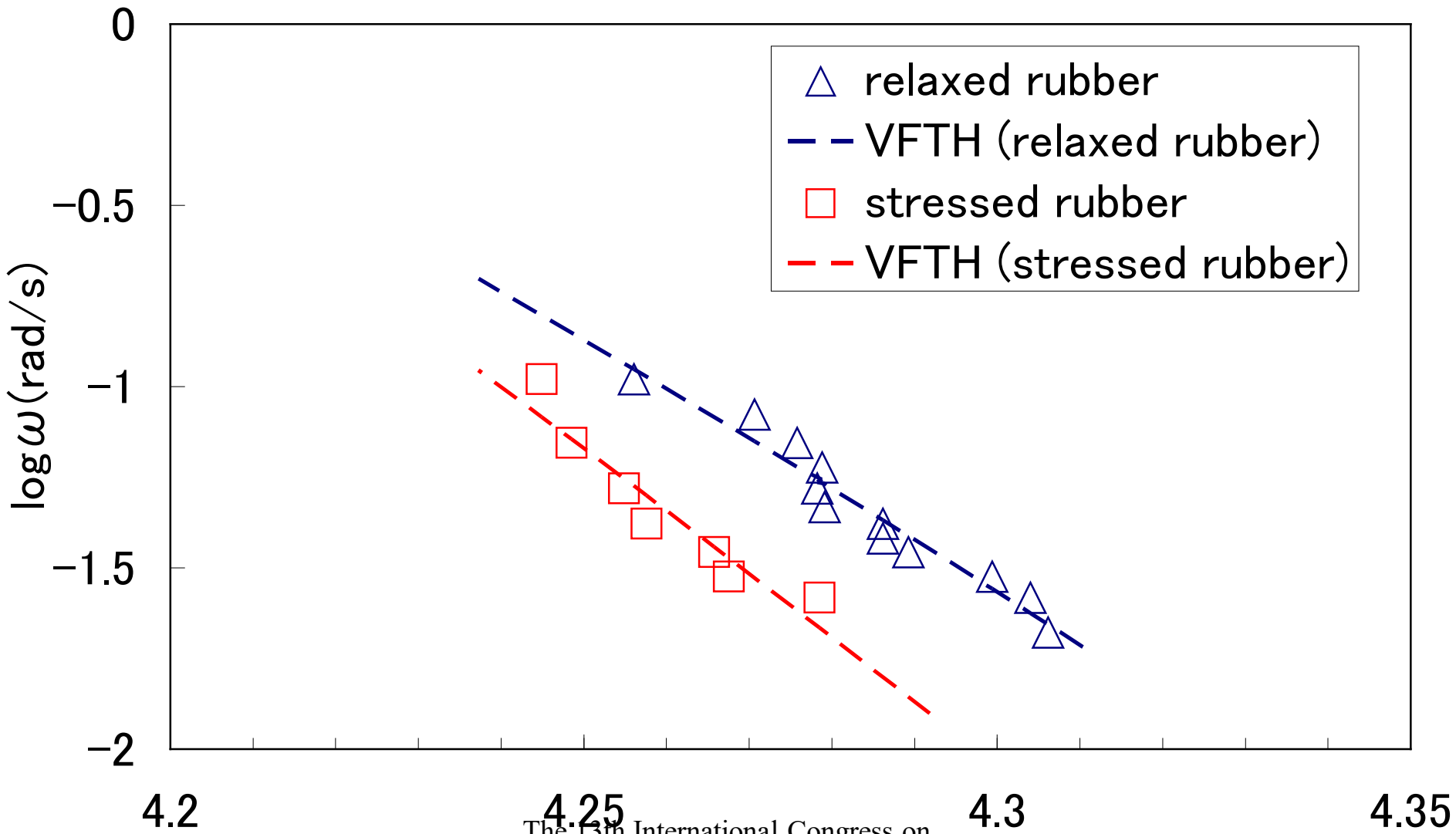
$$A = 22.12$$

$$B = -1756.17 \text{ K}$$

$$T_{\infty} = 159.89 \text{ K}$$

The stressed rubber's T_g is lower than the relaxed rubber's T_g .

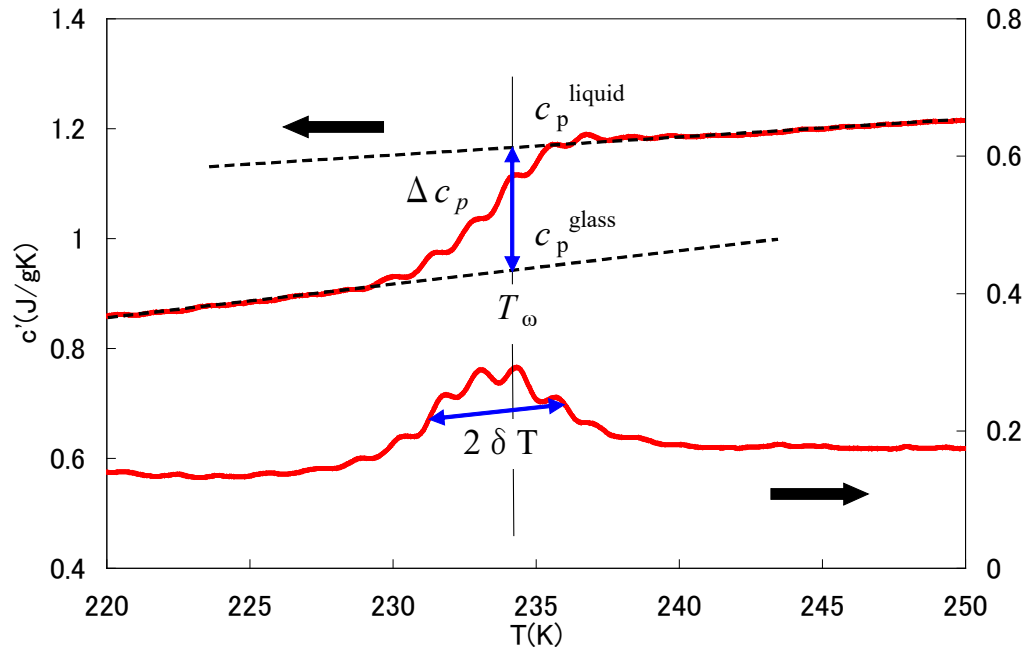
Relaxed and stressed rubber can be fitted by the VFTH.



We used the **fluctuation approach** to obtain the temperature dependent on the glass transition **cooperativity** N_α .

$$N_\alpha \cong \frac{RT_\omega^2 \Delta(1/C_p)}{M_0 \delta T^2}$$

[2] S.Weyer et al



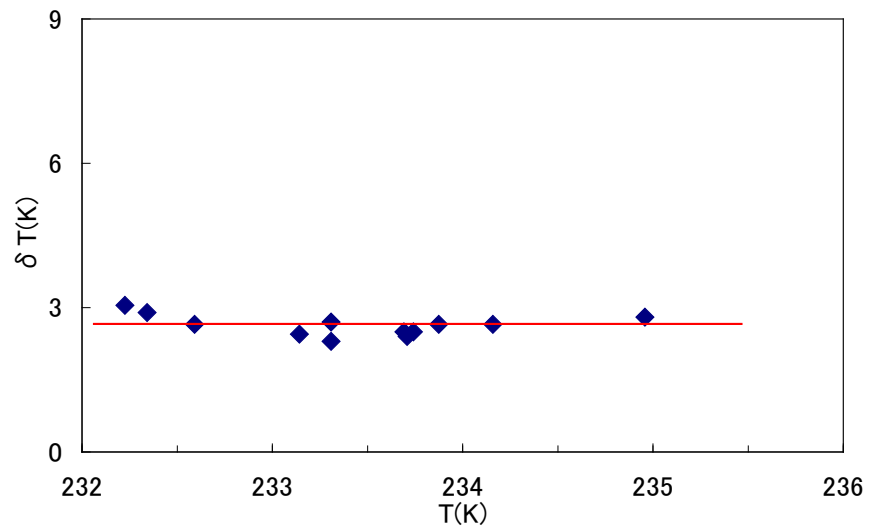
$$\Delta(1/C_p) = 1/C_p^{glass} - 1/C_p^{liquid}$$

R : the gas constant

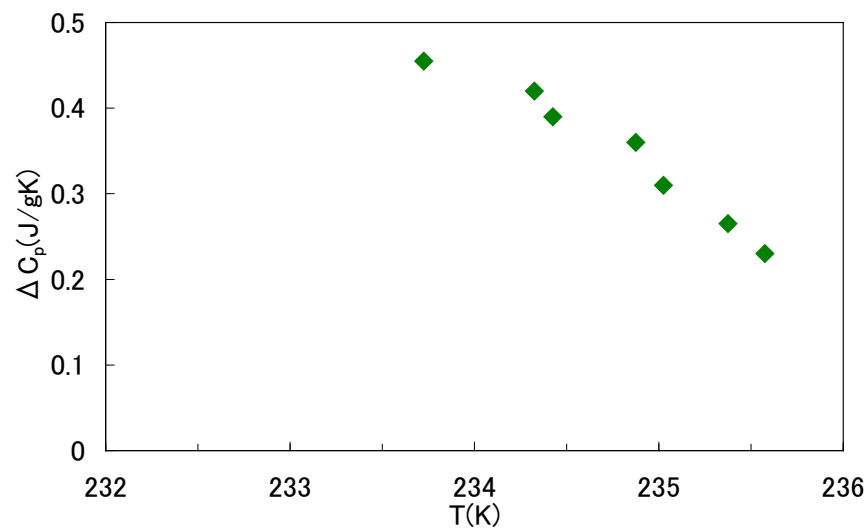
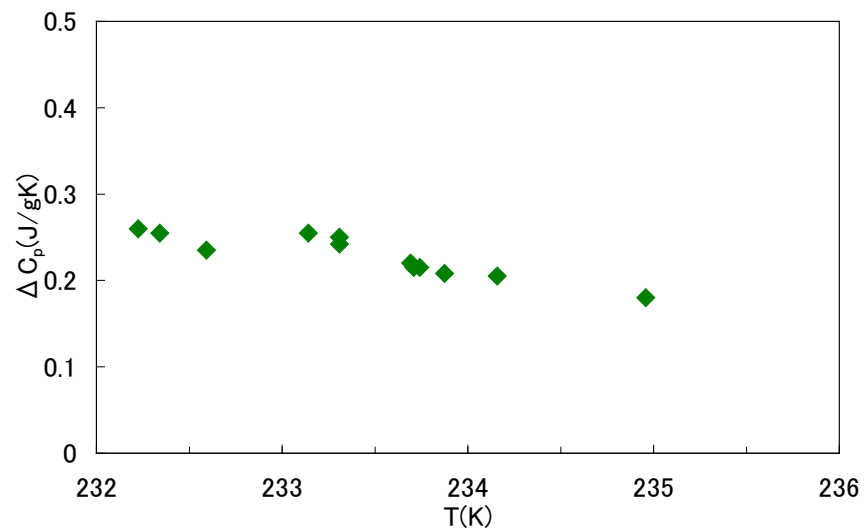
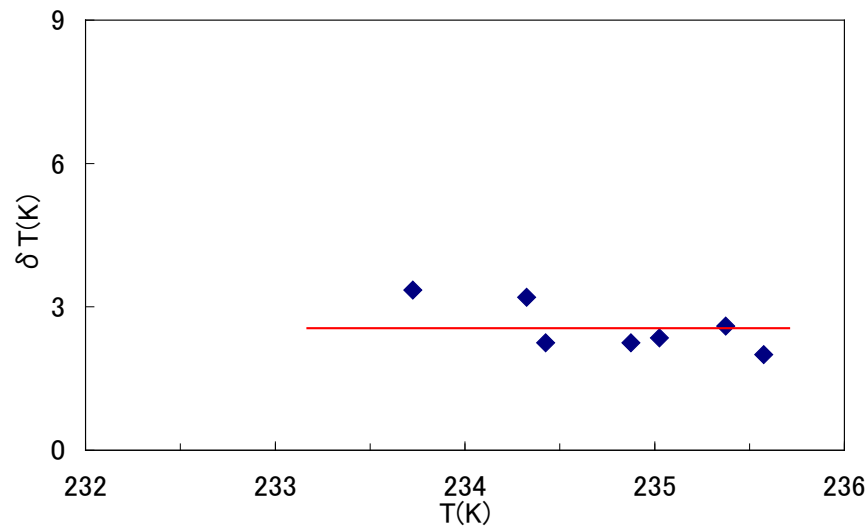
T_ω : the dynamic glass transition temperature for the frequency ω

M_0 : the molecular weight of the relevant particle

Relaxed rubber



Stressed rubber

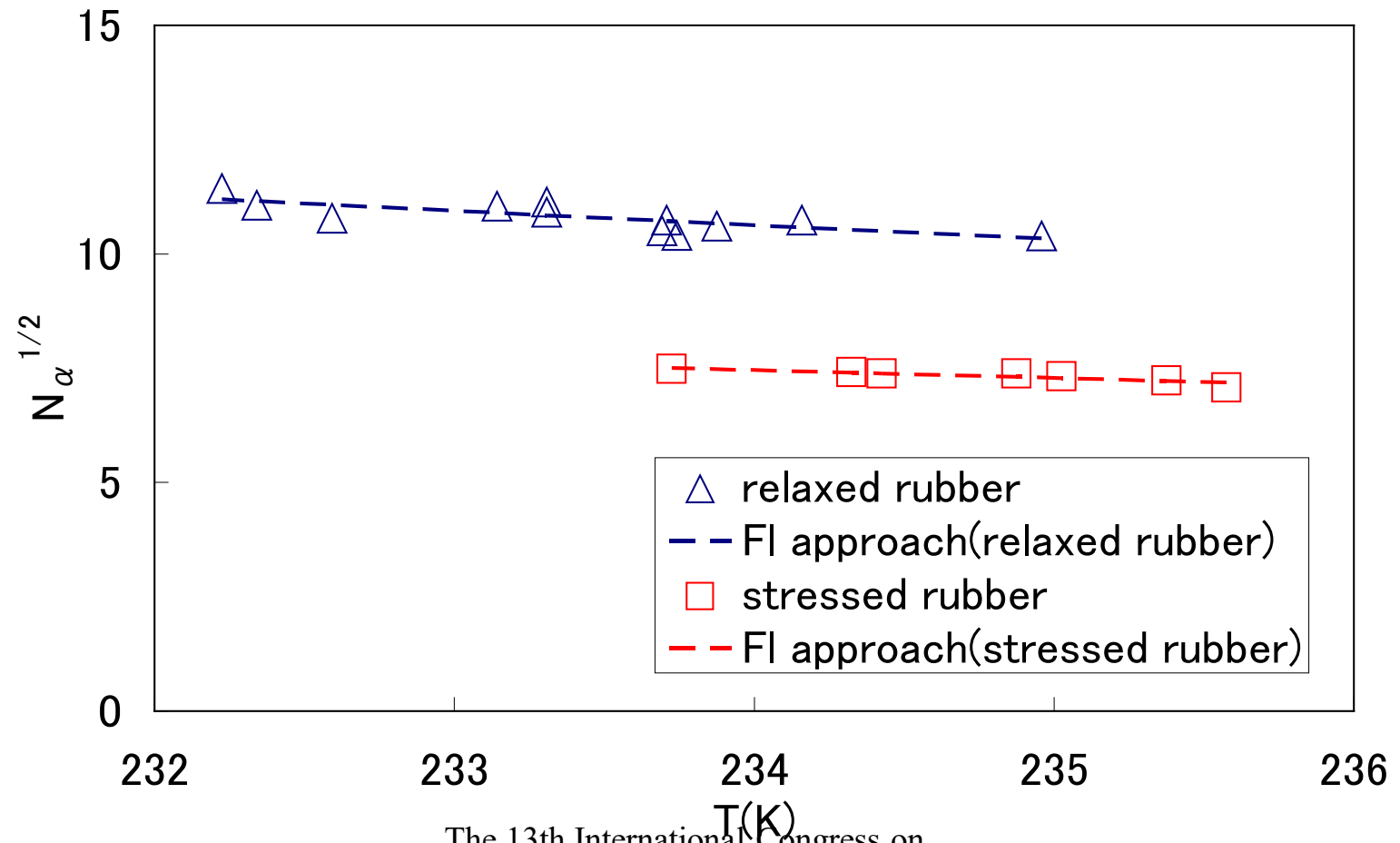


Fluctuation approach

$$N_{\alpha}^{1/2}(T) = A \left(\frac{T_{on} - T}{T - T_{\infty}} \right)$$

T_{∞} : the Vogel temperature by VFTH equation

[2] S.Weyer et al



The thick lines are fits by the fluctuation approach.



Discussion

Cooperativity parameter :

	A	T _{on} (K)
relaxed rubber	5.45	335.6
stressed rubber	5.37	337.0
Other materials		
polystyrene	10.9	429
styrene butadiene rubber	6.8	275

Both rubbers have nearly same parameter.

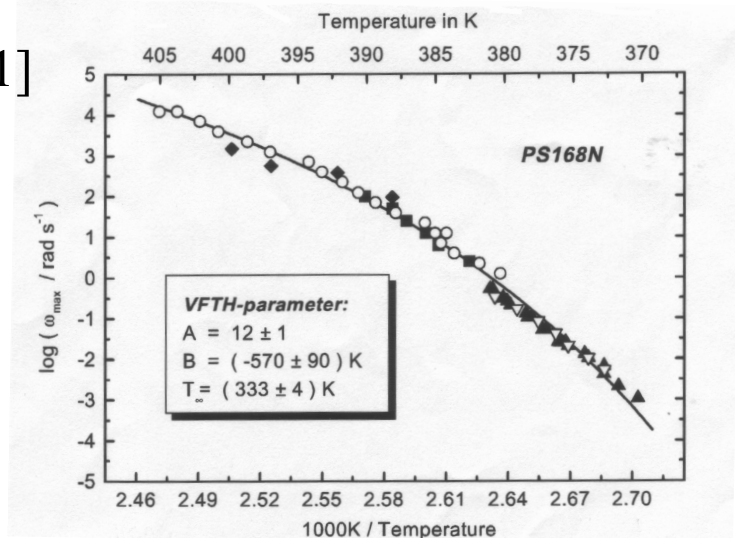


Conclusion

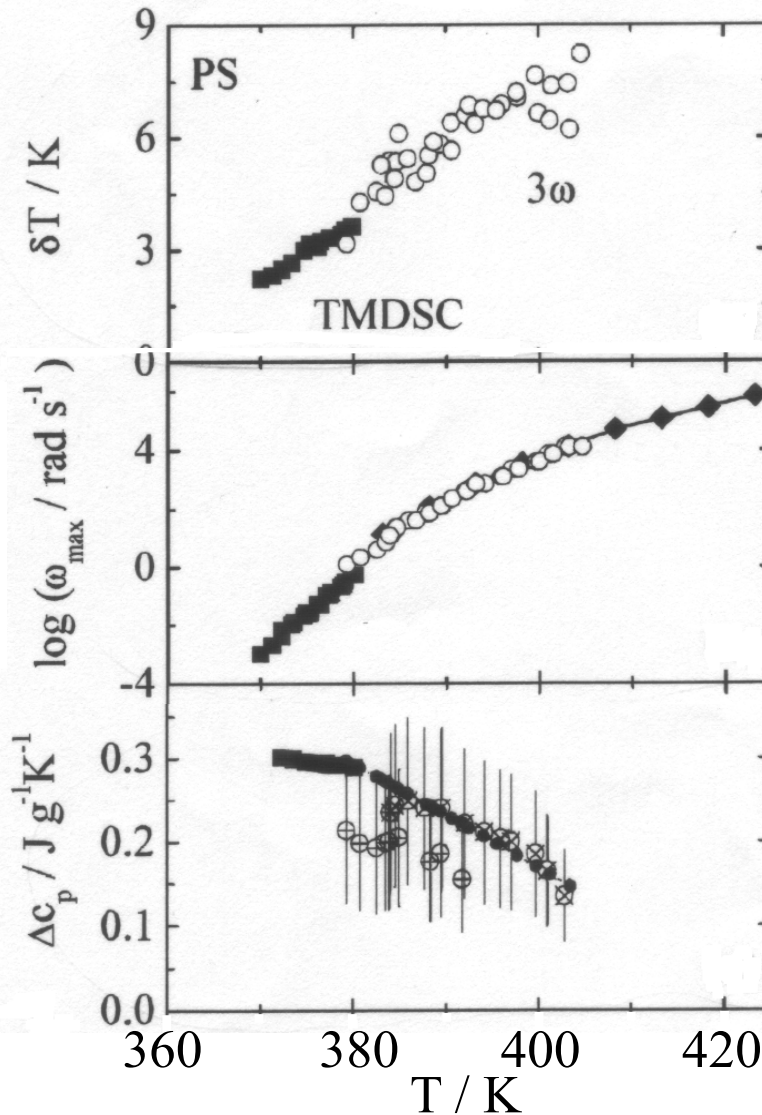
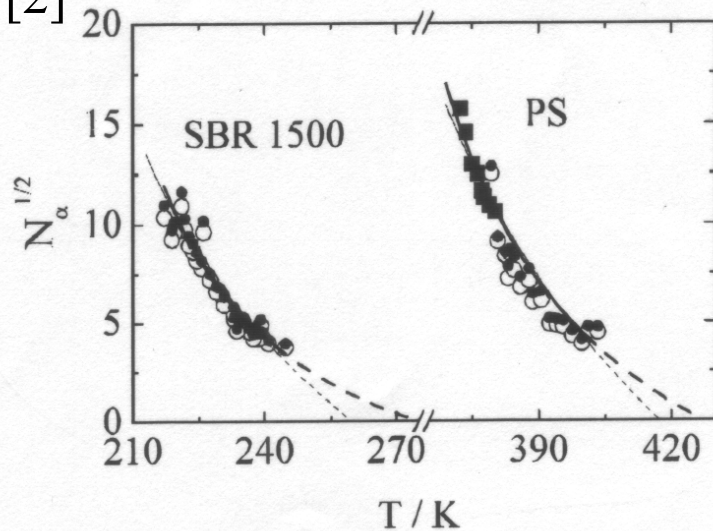
- Measurement of the rubber **under stress** can be performed in TMDSC by using normally optioned pressure pan.
- The relaxed and stressed rubber can fit by the **VFTH equation** similarly.
- Although N_α value is different between both of rubbers, their temperature dependencies are same.
- Glass transition behavior for the **stressed rubber** can be explained **cooperativity**.

Reference

[1]



[2]



[1] H.Huth et al. / *Thermochimica Acta* 377 (2001) 133-124

[2] S.Weyer et al. / *Thermochimica Acta* 377 (2001) 85-96

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